



N-Channel Enhancement-Mode Vertical DMOS Power FETs

Ordering Information

$BV_{DSS} /$ BV_{DGS}	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package			
			TO-39	TO-92	TO-220	Dice
450V	16Ω	0.5A	VN0645N2	VN0645N3	VN0645N5	VN0645ND
500V	16Ω	0.5A	VN0650N2	VN0650N3	VN0650N5	VN0650ND

Features

- ☐ Freedom from secondary breakdown
- ☐ Low power drive requirement
- ☐ Ease of paralleling
- ☐ Low C_{ISS} and fast switching speeds
- ☐ Excellent thermal stability
- ☐ Integral Source-Drain diode
- ☐ High input impedance and high gain
- ☐ Complementary N- and P-Channel devices

Applications

- ☐ Motor control
- ☐ Converters
- ☐ Amplifiers
- ☐ Switches
- ☐ Power supply circuits
- ☐ Drivers (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

*Distance of 1.6 mm from case for 10 seconds.

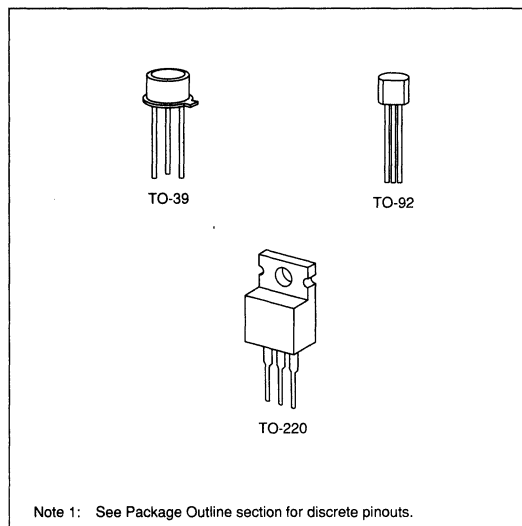
Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options

(Note 1)



Note 1: See Package Outline section for discrete pinouts.

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)*	Power Dissipation @ $T_C = 25^\circ\text{C}$	θ_{JC} $^\circ\text{C/W}$	θ_{JA} $^\circ\text{C/W}$	I_{DR}	I_{DRM}^*
TO-92	0.2A	1.0A	1W	125	170	0.2A	1.0A
TO-39	0.4A	1.5A	6W	21	125	0.4A	1.5A
TO-220	1.0A	1.5A	28W	2.7	70	1.0A	1.5A

* I_D (continuous) is limited by max rated T_J .

Electrical Characteristics (@ 25°C unless otherwise specified)

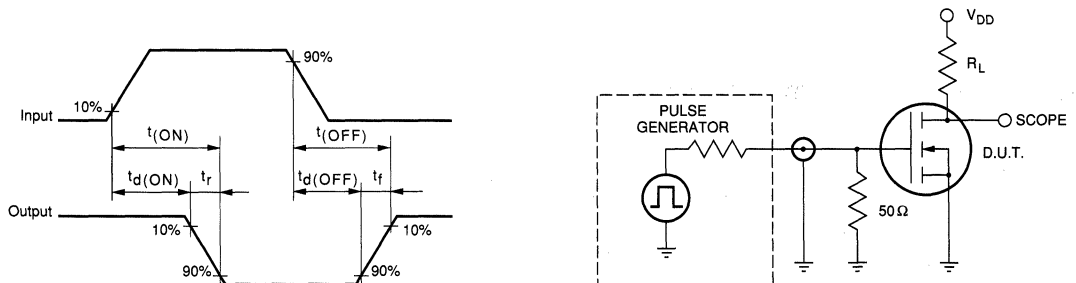
(Notes 1 and 2)

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	VN0645 450 VN0650 500			V	$V_{GS} = 0, I_D = 2\text{mA}$
$V_{GS(th)}$	Gate Threshold Voltage	2		4	V	$V_{GS} = V_{DS}, I_D = 2\text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature			-4.5	mV/ $^\circ\text{C}$	$V_{GS} = V_{DS}, I_D = 2\text{mA}$
I_{GSS}	Gate Body Leakage			100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
I_{DSS}	Zero Gate Voltage Drain Current			10 1	μA mA	$V_{GS} = 0, V_{DS} = \text{Max Rating}$ $V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(ON)}$	ON-State Drain Current		0.7 0.5		A	$V_{GS} = 5\text{V}, V_{DS} = 25\text{V}$ $V_{GS} = 10\text{V}, V_{DS} = 25\text{V}$
$R_{DS(ON)}$	Static Drain-to-Source ON-State Resistance		15 13	16	Ω	$V_{GS} = 5\text{V}, I_D = 100\text{mA}$ $V_{GS} = 10\text{V}, I_D = 400\text{mA}$
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature			0.75	%/ $^\circ\text{C}$	$V_{GS} = 10\text{V}, I_D = 400\text{mA}$
G_{FS}	Forward Transconductance	100			mS	$V_{DS} = 25\text{V}, I_D = 400\text{mA}$
C_{ISS}	Input Capacitance		85	130	pF	$V_{GS} = 0, V_{DS} = 25\text{V}$ $f = 1 \text{ MHz}$
C_{OSS}	Common Source Output Capacitance		50	75	pF	
C_{RSS}	Reverse Transfer Capacitance		10	20	pF	
$t_{d(ON)}$	Turn-ON Delay Time			10	ns	$V_{DD} = 25\text{V}$ $I_D = 0.4\text{A}$ $R_S = 50\Omega$
t_r	Rise Time			10		
$t_{d(OFF)}$	Turn-OFF Delay Time			20		
t_f	Fall Time			10		
V_{SD}	Diode Forward Voltage Drop			1.8	V	$V_{GS} = 0, I_{SD} = 0.4\text{A}$
t_{rr}	Reverse Recovery Time		300		ns	$V_{GS} = 0, I_{SD} = 0.4\text{A}$

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 μs pulse, 2% duty cycle.)

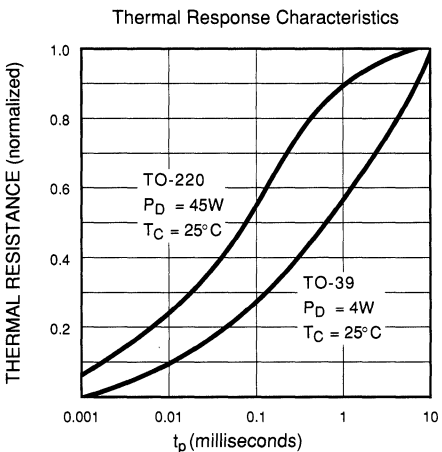
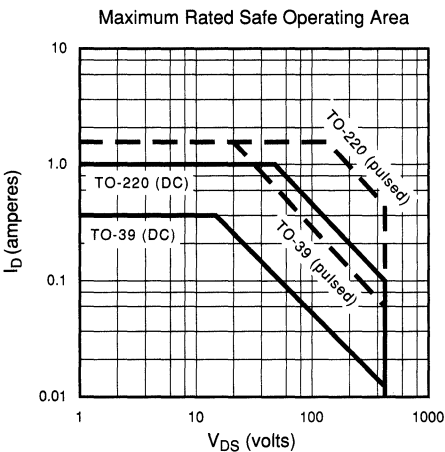
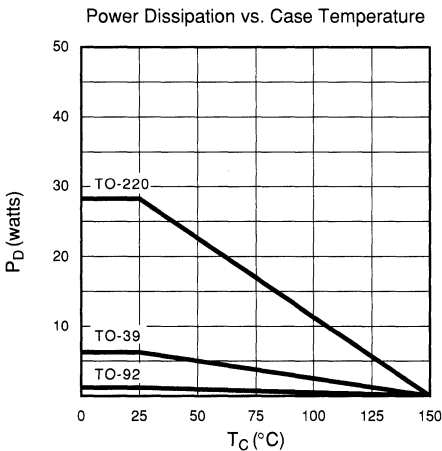
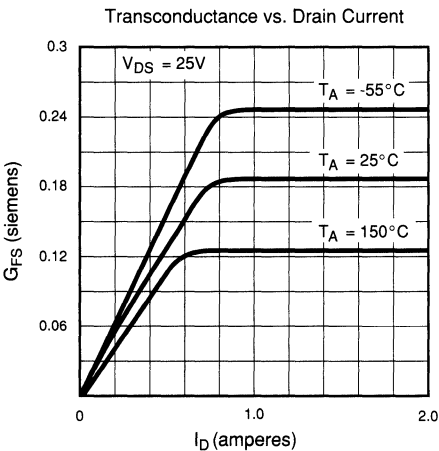
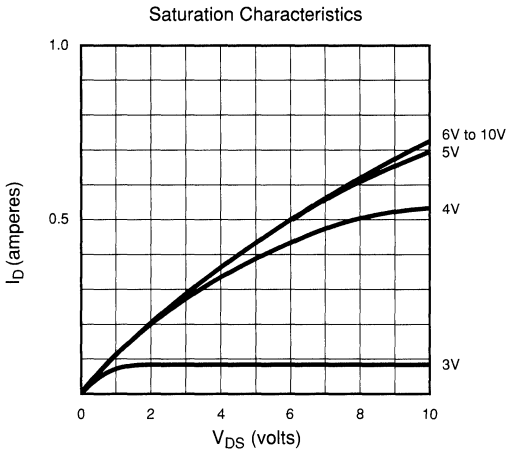
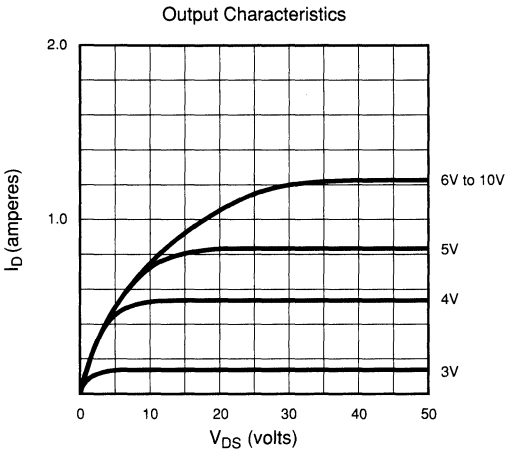
Note 2: All A.C. parameters sample tested.

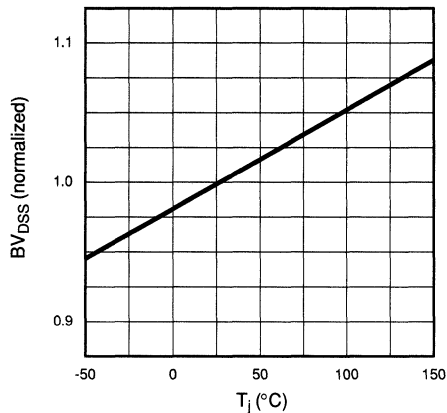
Switching Waveforms and Test Circuit



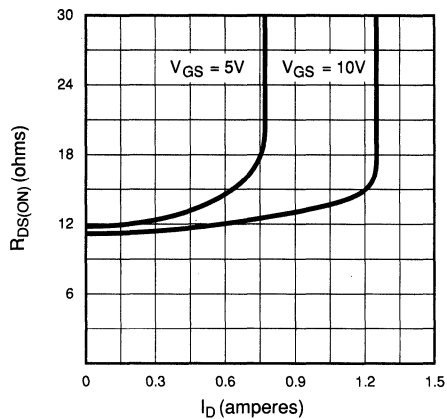
Typical Performance Curves

VN06E

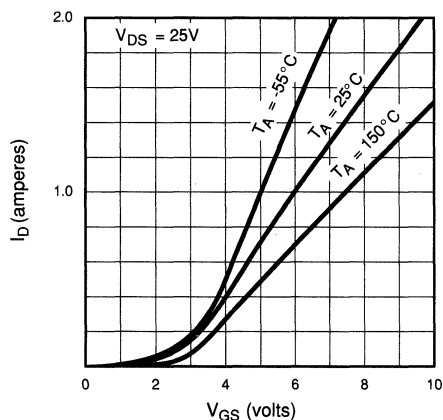
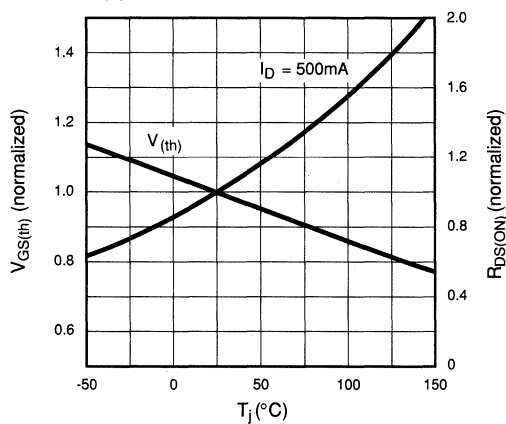


BV_{DSS} Variation with Temperature

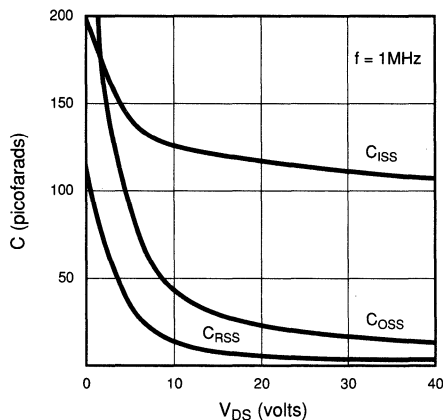
On-Resistance vs. Drain Current



Transfer Characteristics

V_(th) and R_{DS} Variation with Temperature

Capacitance vs. Drain-to-Source Voltage



Gate Drive Dynamic Characteristics

